

LMV301 Low Input Bias Current, 1.8V Op Amp w/ Rail-to-Rail Output

Check for Samples: LMV301

FEATURES

- Input Bias Current: 0.182 pA ٠
- Gain Bandwidth Product: 1 MHz
- Supply Voltage at 1.8V: 1.8 to 5 V
- Supply Current: 150 µA
- Input Referred Voltage Noise at 1kHz: . 40nV/√Hz
- DC Gain (600Ω Load): 100 dB .
- Output Voltage Range at 1.8V: 0.024 to 1.77 V
- Input Common-Mode Voltage Range: -0.3 to ±1.2 V

APPLICATIONS

- **Thermocouple Amplifiers**
- **Photo Current Amplifiers**
- Transducer Amplifiers

Connection Diagram

+IN

v- <u>2</u>

-IN ·

- Sample and Hold Circuits
- Low Frequency Active Filters

DESCRIPTION

The LMV301 CMOS operational amplifier is ideal for single supply, low voltage operation with an ensured operating voltage range from 1.8V to 5V. The low input bias current of less than 0.182pA typical, eliminates input voltage errors that may originate from small input signals. This makes the LMV301 ideal for electrometer applications requiring low input leakage such as sensitive photodetection transimpedance amplifiers and sensor amplifiers. The LMV301 also features a rail-to-rail output voltage swing in addition to a input common-mode range that includes ground. The LMV301 will drive a 600Ω resistive load and up to 1000pF capacitive load in unity gain follower applications. The low supply voltage also makes the LMV301 well suited for portable two-cell battery systems and single cell Li-lon systems.

The LMV301 exhibits excellent speed-power ratio, achieving 1MHz at unity gain with low supply current. The high DC gain of 100dB makes it ideal for other low frequency applications.

The LMV301 is offered in a space saving SC70 package, which is only 2.0X2.1X1.0mm. It is also similar to the LMV321 except the LMV301 has a CMOS input.

Applications Circuit

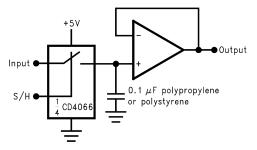


Figure 2. Low Leakage Sample and Hold

Figure 1. SC70-5 Package See Package Number DCK0005A

Top View

<u>5</u> v+

4 OUTPUT



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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Absolute Maximum Ratings⁽¹⁾⁽²⁾

ESD Tolerance ⁽³⁾	Machine Model	200V
	Human Body Model	2000V
Differential Input Voltage		±Supply Voltage
Supply Voltage (V ⁺ - V ⁻)		5.5V
Output Short Circuit to V ⁺⁽⁴⁾		
Output Short Circuit to V ⁻⁽⁴⁾		
Storage Temperature Range		−65°C to 150°C
Mounting Temperature	Infrared or Convection (20 sec)	235°C
Junction Temperature ⁽⁵⁾		150°C

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

(3) Human body model, $1.5k\Omega$ in series with 100pF. Machine model, 200Ω in series with 100pF.

- (4) Applies to both single supply operation. Continuous short circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of 150°C. Output currents in excess of 45mA over long term may adversely affect reliability.
- (5) The maximum power dissipation is a function of $T_{J(MAX)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any ambient temperature is $P_D = (T_{J(MAX)} T_A)\theta_{JA}$. All numbers apply for packages soldered directly into a PC board.

Operating Ratings ⁽¹⁾

Supply Voltage			1.8V to 5.0V
Temperature Range			$-40^{\circ}C \le T_{J} \le +85^{\circ}C$
Thermal Resistance (θ_{JA})	Ultra Tiny SC70-5 Package	5-pin Surface Mount	478°C/W

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.



1.8V DC Electrical Characteristics

Unless otherwise specified, all limits ensured for $T_J = 25^{\circ}C$. V⁺ = 1.8V, V⁻ = 0V, V_{CM} = V⁺/2, V_O = V⁺/2, and R_L > 1M Ω . **Boldface** limits apply at the temperature extremes.

	Parameter	Test Condition	าร	Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
V _{OS}	Input Offset Voltage	$V_{CM} = 0.4V, V^+ = 1.3V, = V^-$	= -0.5V		0.9	8 9	mV
I _B	Input Bias Current				0.182	35 50	pА
I _S	Supply Current	$V_{CM} = 0.4V, V^+ = 1.3V, = V^-$	= −0.5V		150	250 275	μA
CMRR	Common Mode Rejection Ratio	$0.3V \le V_{CM} \le 0.9V$	62 60	108		dB	
PSRR	Power Supply Rejection Ratio	$\begin{array}{l} 1.8 \mathrm{V} \leq \mathrm{V}^{+} \leq 5 \mathrm{V}, \\ 0.9 \leq \mathrm{V}_{\mathrm{CM}} \leq 2.5 \mathrm{V} \end{array}$	67 62	110		dB	
V _{CM}	Input Common-Mode Voltage Range	For CMRR ≥ 50dB	-0.3 0		0.6	V	
A _V Large Signal Voltage Gain Sourcing			80 75	119		- dB	
		$R_L = 2k\Omega$ to 0V, V ⁺ = 1.2V, V = -0.2V to 0.8V, V _{CM} = 0V	80 75	111		uв	
	Sinking	$R_L = 600\Omega$ to 0V, V ⁺ = 1.2V, V _O = -0.2V to 0.8V, V _{CM} = 0	80 75	94			
		$R_L = 2k\Omega$ to 0V, V ⁺ = 1.2V, V = -0.2V to 0.8V, V _{CM} = 0V	80 75	96		dB	
Vo	Output Swing	$R_L = 600\Omega$ to 0.9V V _{IN} = ±100mV	V _{OH}	1.65 1.63	1.72		V
			V _{OL}		0.074	0.100	V
		$R_{L} = 2k\Omega \text{ to } 0.9V$ $V_{IN} = \pm 100 \text{mV}$	V _{OH}	1.75 1.74	1.77		V
			V _{OL}		0.024	0.035 0.040	V
l _O	Output Short Circuit Current	Sourcing, $V_O = 0V, V_{IN} = 100mV$	4 3.3	8.4		mA	
		Sinking, V _O = 1.8V, V _{IN} = −100mV	7	9.8		mA	

(1) All limits are ensured by testing or statistical analysis.

(2) Typical value represent the most likely parametric norm.

1.8V AC Electrical Characteristics

Unless otherwise specified, all limits ensured for $T_J = 25^{\circ}C$. $V^+ = 1.8V$, $V^- = 0V$, $V_{CM} = V^+/2$, $V_O = V^+/2$, and $R_L > 1M\Omega$. Boldface limits apply at the temperature extremes.

	Parameter	Test Conditions	Typ ⁽¹⁾	Units	
SR	Slew Rate	See ⁽²⁾	0.57	V/µs	
GBW	Gain Bandwidth Product		1	MHz	
φm	Phase Margin		60	Deg	
G _m	Gain Margin		10	dB	
e _n	Input-Referred Voltage Noise	$ f = 1 kHz, V_{CM} = 0.5 V $ $ f = 100 kHz $	40 30	nV/√Hz	
THD	Total Harmonic Distortion	$ f = 1 kHz, A_V = +1 \\ RL = 600 k\Omega, V_{IN} = 1 V_{PP} $	0.089	%	

(1) Typical value represent the most likely parametric norm.

(2) $V^+ = 5V$. Connected as voltage follower with 5V step input. Number specified is the slower of the positive and negative slew rates.

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2.7V DC Electrical Characteristics

Unless otherwise specified, all limits ensured for $T_J = 25^{\circ}C$. V⁺ = 2.7V, V⁻ = 0V, V_{CM} = V⁺/2, V_O = V⁺/2, and R_L > 1M Ω . **Boldface** limits apply at the temperature extremes.

	Parameter	Test Conditions	6	Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
V _{OS}	Input Offset Voltage	$V_{CM} = 0.35V, V^+ = 1.7V, V^- =$	-1V		0.9	8 9	mV
I _B	Input Bias Current				0.182	35 50	рА
I _S	Supply Current	$V_{CM} = 0.35V, V^+ = 1.7V, V^- =$	-1V		153	250 275	μA
CMRR	Common Mode Rejection Ratio	$-0.15V \le V_{CM} \le 1.35V$	62 60	115		dB	
PSRR	Power Supply Rejection Ratio	$1.8V \le V + \le 5V$	67 62	110		dB	
V _{CM}	Input Common-Mode Voltage Range	For CMRR ≥ 50dB	-0.3 0		1.5	V	
A _V Large Signal Voltage Gain Sourcing		$R_L = 600\Omega$ to 0V, V ⁺ = 1.35V -1.35V, V _O = -1V to 1V, V _{CM}	80 75	100		-ID	
			83 77	114		- dB	
	Sinking	$R_L = 600\Omega$ to 0V, V ⁺ = 1.35V -1.35V, V _O = -1V to 1V, V _{CM}	80 75	98		-ID	
			80 75	99		- dB	
Vo	Output Swing	$R_L = 600\Omega$ to 1.35V V _{IN} = ±100mV	V _{OH}	2.550 2.530	2.62		V
			V _{OL}		0.078	0.100	V
		$R_L = 2k\Omega$ to 1.35V V _{IN} = ±100mV	V _{OH}	2.650 2.640	2.675		V
			V _{OL}		0.024	0.045	V
I _O Output Short Circuit Current		Sourcing, $V_0 = 0V, V_{IN} = 100mV$	20 15	32		mA	
		Sinking, V _O = 2.7V, V _{IN} = −100mV	19 12	24		mA	

(1) All limits are ensured by testing or statistical analysis.

(2) Typical value represent the most likely parametric norm.

2.7V AC Electrical Characteristics

Unless otherwise specified, all limits ensured for $T_J = 25^{\circ}C$. V⁺ = 2.7V, V⁻ = 0V, V_{CM} = 1.0V, V_O = 1.35V and R_L > 1M Ω . **Boldface** limits apply at the temperature extremes.

	Parameter	r Test Conditions			
SR	Slew Rate	See ⁽²⁾	0.60	V/µs	
GBW	Gain Bandwidth Product		1	MHz	
φm	Phase Margin		65	Deg	
G _m	Gain Margin		10	dB	
e _n	Input-Referred Voltage Noise	$ f = 1 kHz, V_{CM} = 0.5V $ $ f = 100 kHz $	40 30	nV/√Hz	
THD	Total Harmonic Distortion	$ f = 1 kHz, A_V = +1 R_L = 600 k\Omega, V_{IN} = 1 V_{PP} $	0.077	%	

(1) Typical value represent the most likely parametric norm.

(2) $V^+ = 5V$. Connected as voltage follower with 5V step input. Number specified is the slower of the positive and negative slew rates.



5V DC Electrical Characteristics

Unless otherwise specified, all limits ensured for $T_J = 25^{\circ}$ C. V⁺ = 5V, V⁻ = 0V, $V_{CM} = V^+/2$, $V_O = V^+/2$, and $R_L > 1M\Omega$. **Boldface** limits apply at the temperature extremes.

	Parameter	Test Conditions		Min ⁽¹⁾	Typ ⁽²⁾	Max ⁽¹⁾	Units
V _{OS}	Input Offset Voltage	$V_{CM} = 0.5V, V^+ = 3V, V^- = -2$	V		0.9	8 9	mV
IB	Input Bias Current				0.182	35 50	pА
I _S	Supply Current	$V_{CM} = 0.5V, V^+ = 3V, V^- = -2$	V		163	260 285	μA
CMRR	Common Mode Rejection Ratio	$-1.3V \le V_{CM} \le 2.5V$		62 61	111		dB
PSRR	Power Supply Rejection Ratio	$1.8V \le V^+ \le 5V$		67 62	110		dB
V _{CM}	Input Common-Mode Voltage Range	For CMRR ≥ 50dB		-0.3 0		3.8	V
A _V Large Signal Voltage Gain Sourcing		$ \begin{array}{l} R_{L} = 600\Omega \text{ to } 0V, V^{+} = 2.5V, V \\ V_{O} = -2V \text{ to } 2V, V_{CM} = 0V \end{array} $	86 82	117		-ID	
		$ \begin{array}{l} R_{L} = 2k\Omega \text{ to } 0V, \ V^{+} = 2.5V, \ V^{-}\\ V_{O} = -2V \text{ to } 2V, \ V_{CM} = 0V \end{array} $	89 85	116		dB	
	Sinking	$R_L = 600\Omega$ to 0V, V ⁺ = 2.5V, V V _O = -2V to 2V, V _{CM} = 0V	√ ⁻ = −2.5V,	80 75	105		-ID
		$ \begin{array}{l} R_{L} = 2k\Omega \text{ to } 0V, \ V^{+} = 2.5V, \ V^{-} \\ V_{O} = -2V \text{ to } 2V, \ V_{CM} = 0V \end{array} $	80 75	107		dB	
Vo	Output Swing	$R_L = 600\Omega$ to 2.5V V _{IN} = ±100mV	V _{OH}	4.850 4.840	4.893		V
			V _{OL}		0.1	0.150 1.160	V
		$R_L = 2k\Omega$ to 2.5V	V _{OH}	4.935	4.966		V
		$V_{IN} = \pm 100 \text{mV}$	V _{OL}		0.034	0.065 0.075	V
I _O Output Short Circuit Current		Sourcing, $V_0 = 0V$, $V_{IN} = 100mV$		85 68	108		mA
		Sinking, $V_0 = 5V$, $V_{IN} = -100mV$		60 45	69		mA

(1) All limits are ensured by testing or statistical analysis.

(2) Typical value represent the most likely parametric norm.

5V AC Electrical Characteristics

Unless otherwise specified, all limits ensured for $T_J = 25^{\circ}C$. $V^+ = 5V$, $V^- = 0V$, $V_{CM} = V^+/2$, $V_O = 2.5V$ and $R_L > 1M\Omega$. **Boldface** limits apply at the temperature extremes.

	Parameter	Parameter Test Conditions			
SR	Slew Rate	See ⁽²⁾	0.66	V/µs	
GBW	Gain Bandwidth Product		1	MHz	
φm	Phase Margin		70	Deg	
G _m	Gain Margin		15	dB	
e _n	Input-Referred Voltage Noise	$f = 1 kHz$, $V_{CM} = 1V$ f = 100 kHz	40 30	nV/√Hz	
THD	Total Harmonic Distortion	$ f = 1 kHz, A_V = +1 \\ R_L = 600\Omega, V_O = 1 V_{PP} $	0.069	%	

(1) Typical value represent the most likely parametric norm.

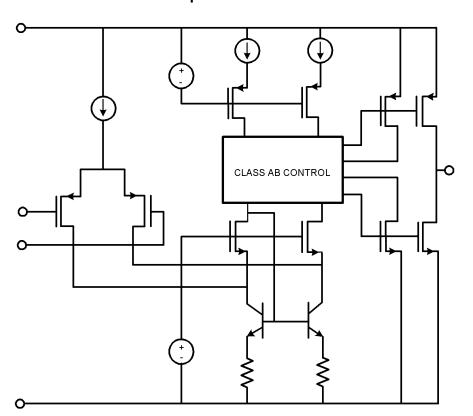
(2) $V^+ = 5V$. Connected as voltage follower with 5V step input. Number specified is the slower of the positive and negative slew rates.

TEXAS INSTRUMENTS

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Simplified Schematic





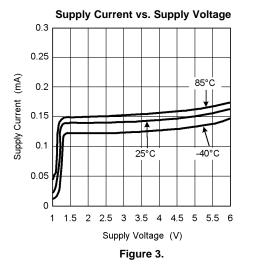


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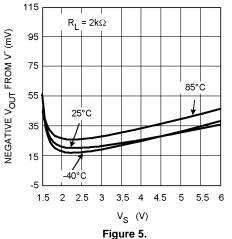
LMV301

Typical Performance Characteristics

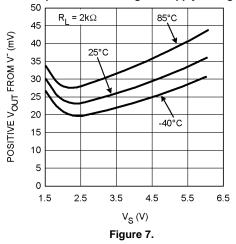
Unless otherwise specified, $T_A = 25^{\circ}C$.

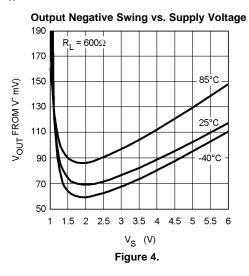




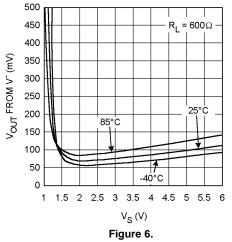


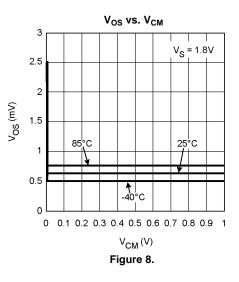
Output Positive Swing vs. Supply Voltage





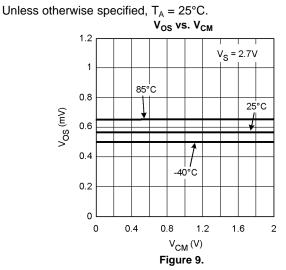
Output Positive Swing vs. Supply Voltage



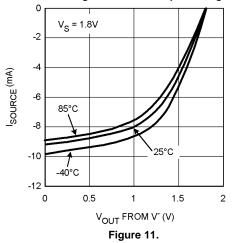


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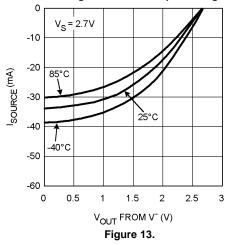
Typical Performance Characteristics (continued)

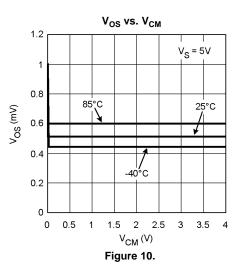


Sourcing Current vs. Output Voltage

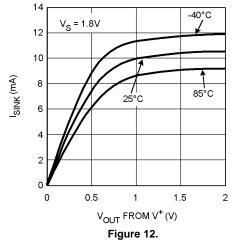


Sourcing Current vs. Output Voltage

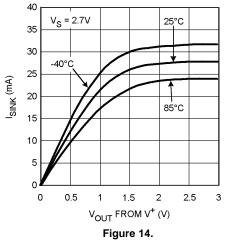




Sinking Current vs. Output Voltage

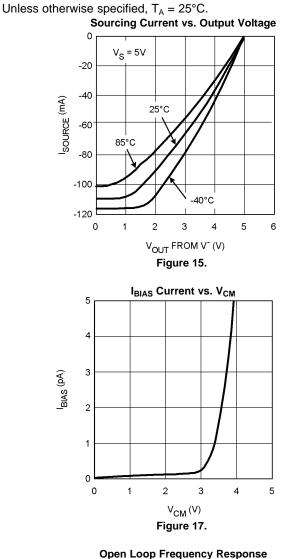


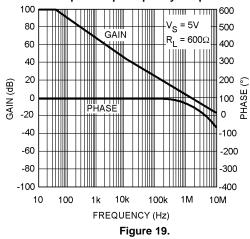
Sinking Current vs. Output Voltage

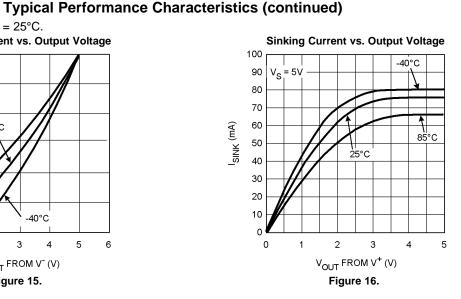


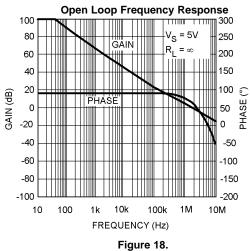


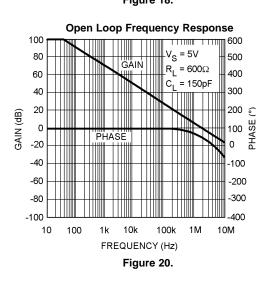
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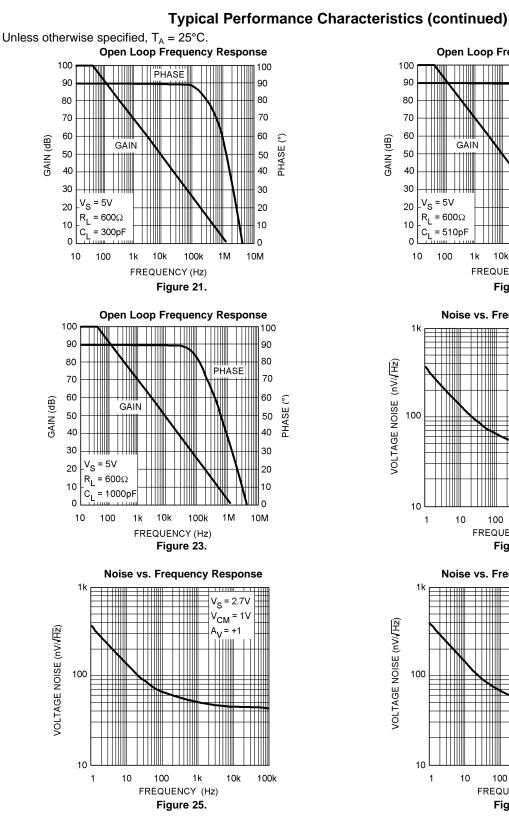


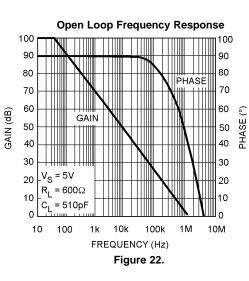


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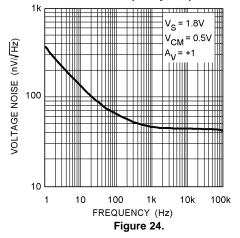
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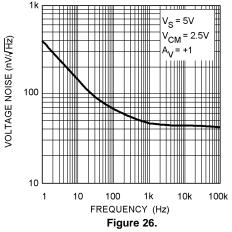




Noise vs. Frequency Response





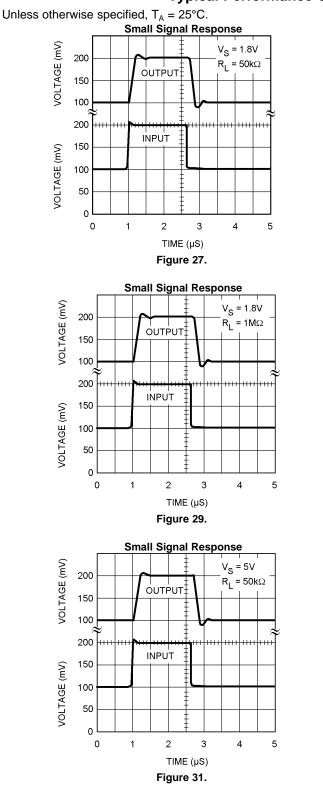


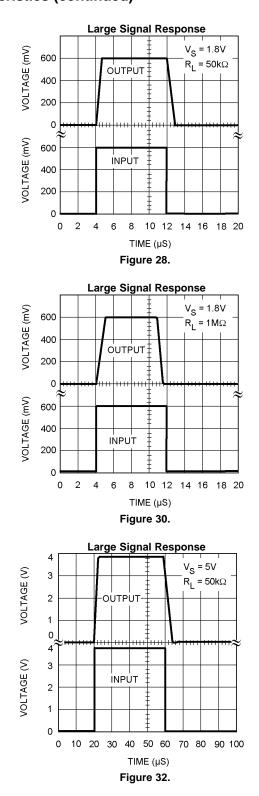


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Typical Performance Characteristics (continued)

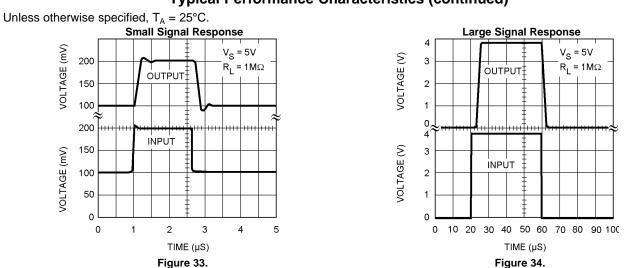




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Typical Performance Characteristics (continued)



(1)

APPLICATION HINTS

Compensating Input Capacitance

The high input resistance of the LMV301 op amp allows the use of large feedback and source resistor values without losing gain accuracy due to loading. However, the circuit will be especially sensitive to its layout when these large value resistors are used.

Every amplifier has some capacitance between each input and AC ground, and also some differential capacitance between the inputs. When the feedback network around an amplifier is resistive, this input capacitance (along with any additional capacitance due to circuit board traces, the socket, etc.) and the feedback resistors create a pole in the feedback path. In the following General Operational Amplifier circuit, Figure 35, the frequency of this pole is

$$fp = \frac{1}{2\pi C_S R_P}$$

where

- C_s is the total capacitance at the inverting input, including amplifier input capacitance and any stray capacitance from the IC socket (if one is used), circuit board traces, etc.,
- R_{P} is the parallel combination of R_{F} and R_{IN}

This formula, as well as all formulae derived below, apply to inverting and non-inverting op amp configurations.

When the feedback resistors are smaller than a few $k\Omega$, the frequency of the feedback pole will be quite high, since C_S is generally less than 10pF. If the frequency of the feedback pole is much higher than the "ideal" closedloop bandwidth (the nominal closed-loop bandwidth in the absence of C_S), the pole will have a negligible effect on stability, as it will add only a small amount of phase shift.

However, if the feedback pole is less than approximately 6 to 10 times the "ideal" -3dB frequency, a feedback capacitor, C_F, should be connected between the output and the inverting input of the op amp. This condition can also be stated in terms of the amplifier's low frequency noise gain. To maintain stability a feedback capacitor will probably be needed if

$$\left(\frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}}+1\right) \le \sqrt{6 \times 2\pi \times \mathsf{GBW} \times \mathsf{R}_{\mathsf{F}} \times \mathsf{C}_{\mathsf{S}}} \tag{2}$$

Where

$$\left(\frac{R_{\rm F}}{R_{\rm IN}} + 1\right)$$
 (3)

is the amplifier's low frequency noise gain and GBW is the amplifier's gain bandwidth product.

An amplifier's low frequency noise gain is represented by the formula

$$\left(\frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}}+1\right) \tag{4}$$

regardless of whether the amplifier is being used in inverting or non-inverting mode. Note that a feedback capacitor is more likely to be needed when the noise gain is low and/or the feedback resistor is large.

If the above condition is met (indicating a feedback capacitor will probably be needed), and the noise gain is large enough that:

$$\left(\frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}}+1\right) \geq 2\sqrt{\mathsf{GBW} \times \mathsf{R}_{\mathsf{F}} \times \mathsf{C}_{\mathsf{S}}}, \tag{5}$$

the following value of feedback capacitor is recommended:

$$C_{\mathsf{F}} = \frac{C_{\mathsf{S}}}{2\left(\frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}} + 1\right)} \tag{6}$$

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NSTRUMENTS

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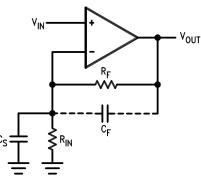
$$\left(\frac{\mathsf{R}_{\mathsf{F}}}{\mathsf{R}_{\mathsf{IN}}}+1\right) < 2\sqrt{\mathsf{GBW} \times \mathsf{R}_{\mathsf{F}} \times \mathsf{C}_{\mathsf{S}}} \tag{7}$$

the feedback capacitor should be:

$$C_{\mathsf{F}} = \sqrt{\frac{C_{\mathsf{S}}}{\mathsf{GBW} \times \mathsf{R}_{\mathsf{F}}}} \tag{8}$$

Note that these capacitor values are usually significantly smaller than those given by the older, more conservative formula:

$$C_{\mathsf{F}} = \frac{C_{\mathsf{S}}\mathsf{R}_{\mathsf{IN}}}{\mathsf{R}_{\mathsf{F}}} \tag{9}$$



 C_S consists of the amplifier's input capacitance plus any stray capacitance from the circuit board and socket. C_F compensates for the pole caused by C_S and the feedback resistors.

Figure 35. General Operational Amplifier Circuit

Using the smaller capacitor will give much higher bandwidth with little degradation of transient response. It may be necessary in any of the above cases to use a somewhat larger feedback capacitor to allow for unexpected stray capacitance, or to tolerate additional phase shifts in the loop, or excessive capacitive load, or to decrease the noise or bandwidth, or simply because the particular circuit implementation needs more feedback capacitance to be sufficiently stable. For example, a printed circuit board's stray capacitance may be larger or smaller than the breadboard's, so the actual optimum value for C_F may be different from the one estimated using the breadboard. In most cases, the values of C_F should be checked on the actual circuit, starting with the computed value.

Capacitive Load Tolerance

Like many other op amps, the LMV301 may oscillate when its applied load appears capacitive. The threshold of oscillation varies both with load and circuit gain. The configuration most sensitive to oscillation is a unity gain follower. The load capacitance interacts with the op amp's output resistance to create an additional pole. If this pole frequency is sufficiently low, it will degrade the op amp's phase margin so that the amplifier is no longer stable. As shown in Figure 36, the addition of a small resistor (50Ω to 100Ω) in series with the op amp's output, and a capacitor (5pF to 10pF) from inverting input to output pins, returns the phase margin to a safe value without interfering with lower frequency circuit operation. Thus, larger values of capacitance can be tolerated without oscillation. Note that in all cases, the output will ring heavily when the load capacitance is near the threshold for oscillation.



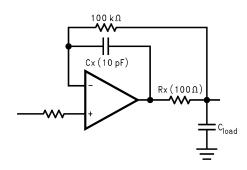


Figure 36. Rx, Cx Improve Capacitive Load Tolerance

Capacitive load driving capability is enhanced by using a pull up resistor to V⁺ (Figure 37). Typically a pull up resistor conducting 500 μ A or more will significantly improve capacitive load responses. The value of the pull up resistor must be determined based on the current sinking capability of the amplifier with respect to the desired output swing. Open loop gain of the amplifier can also be affected by the pull up resistor.

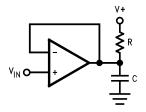


Figure 37. Compensating for Large Capacitive Loads with a Pull Up Resistor

PRINTED-CIRCUIT-BOARD LAYOUT FOR HIGH-IMPEDANCE WORK

It is generally recognized that any circuit which must operate with less than 100pA of leakage current requires special layout of the PC board. When one wishes to take advantage of the low bias current of the LMV301, typically less than 0.182pA, it is essential to have an excellent layout. Fortunately, the techniques for obtaining low leakages are guite simple. First, the user must not ignore the surface leakage of the PC board, even though it may sometimes appear acceptable low, because under conditions of the high humidity or dust or contamination, the surface leakage will be appreciable. To minimized the effect of any surface leakage, lay out a ring of foil completely surrounding the LMV301's inputs and the terminals of capacitors, diodes, conductors, resistors, relay terminals, etc. connected to the op amp's inputs. See Figure 38. To have a significant effect, guard rings should be placed on both the top and bottom of the PC board. The PC foil must then be connected to a voltage which is at the same voltage as the amplifier inputs, since no leakage current can flow between two points at the same potential. For example, a PC board trace-to-pad resistance of 10¹²Ω, which is normally considered a very large resistance, could leak 5pA if the trace were a 5V bus adjacent to the pad of an input. This would cause a 100 times degradation from the LMV301's actual performance. However, if a guard ring is held within 5mV of the inputs, then even a resistance of $10^{11}\Omega$ would cause only 0.05pA of leakage current, or perhaps a minor (2:1) degradation of the amplifier performance. See Figure 39, Figure 40, and Figure 41 for typical connections of guard rings for standard op amp configurations. If both inputs are active and at high impedance, the guard can be tied to ground and still provide some protection; see Figure 42.

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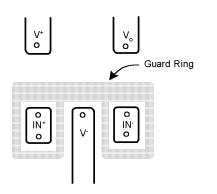
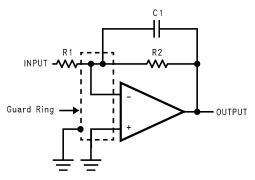
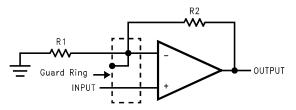


Figure 38. Example, using the LMV301, of Guard Ring in P.C. Board Layout

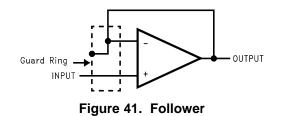
Guard Ring Connections













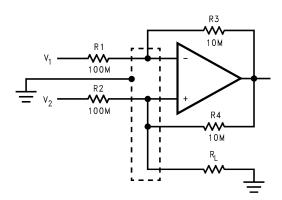
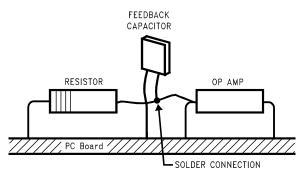


Figure 42. Howland Current Pump

The designer should be aware that when it is inappropriate to lay out a PC board for the sake of just a few circuits, there is another technique which is even better than a guard ring on a PC board: Don't insert the amplifier's input pin into the board at all, but bend it up in the air and use only air as an insulator. Air is an excellent insulator. In this case you may have to forego some of the advantages of PC board construction, but the advantages are sometimes well worth the effort of using point-to-point up-in-the-air wiring. See Figure 43.



(Input pins are lifted out of PC board and soldered directly to components. All other pins connected to PC board.)

Figure 43. Air Wiring

Typical Single-Supply Applications

 $(V_{+} = 5.0 \text{ VDC})$

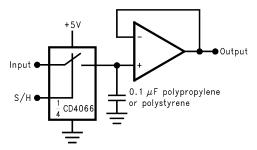


Figure 44. Low-Leakage Sample-and-Hold



(10)

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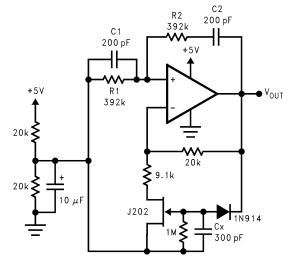


Figure 45. Sine-Wave Oscillator

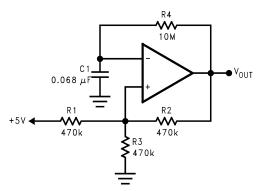
Oscillator frequency is determined by R1, R2, C1, and C2:

 $fosc = 1/2\pi RC$

where

- R = R1 = R2
- C = C1 = C2

This circuit, as shown, oscillates at 2.0kHz with a peak-to-peak output swing of 4.5V.





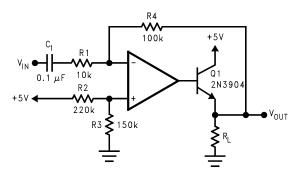
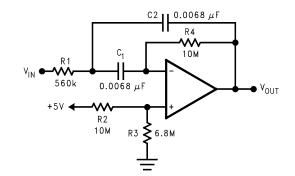


Figure 47. Power Amplifier

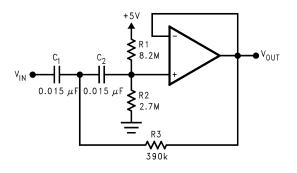


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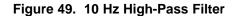


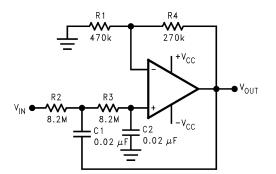
f_O = 10 Hz Q = 2.1 Gain = −8.8





 $\label{eq:fc} \begin{array}{l} f_c = 10 \mbox{ Hz} \\ d = 0.895 \\ \mbox{Gain} = 1 \\ 2 \mbox{ dB passband ripple} \end{array}$





 $\begin{array}{l} f_c = 1 \ Hz \\ d = 1.414 \\ Gain = 1.57 \end{array}$

Figure 50. 1 Hz Low-Pass Filter (Maximally Flat, Dual Supply Only) SNOS968A-MAY 2004-REVISED MAY 2013

REVISION HISTORY

Cł	nanges from Original (May 2013) to Revision A	Page
•	Changed layout of National Data Sheet to TI format	19



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PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
LMV301MG/NOPB	Active	Production	SC70 (DCK) 5	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	A48
LMV301MG/NOPB.A	Active	Production	SC70 (DCK) 5	1000 SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	A48
LMV301MG/NOPB.B	Active	Production	SC70 (DCK) 5	1000 SMALL T&R	-	SN	Level-1-260C-UNLIM	-40 to 85	A48
LMV301MGX/NOPB	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	A48
LMV301MGX/NOPB.A	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	A48
LMV301MGX/NOPB.B	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	-	SN	Level-1-260C-UNLIM	-40 to 85	A48

⁽¹⁾ **Status:** For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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PACKAGE OPTION ADDENDUM

24-Jul-2025

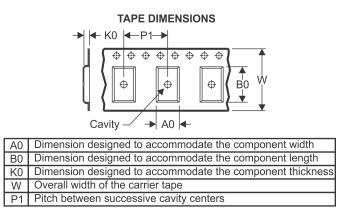
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV301MG/NOPB	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LMV301MGX/NOPB	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3



PACKAGE MATERIALS INFORMATION

29-Oct-2021



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV301MG/NOPB	SC70	DCK	5	1000	208.0	191.0	35.0
LMV301MGX/NOPB	SC70	DCK	5	3000	208.0	191.0	35.0

DCK0005A



PACKAGE OUTLINE

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



DCK0005A

EXAMPLE BOARD LAYOUT

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

Publication IPC-7351 may have alternate designs.
 Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DCK0005A

EXAMPLE STENCIL DESIGN

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

10. Board assembly site may have different recommendations for stencil design.



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